

ESD Protection Diodes Silicon Epitaxial Planar

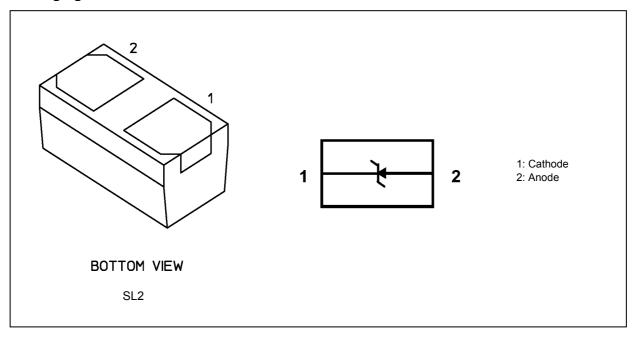
DF2S5.6ASL

1. Applications

· ESD Protection

Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

2. Packaging and Internal Circuit



3. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Note	Rating	Unit
Electrostatic discharge voltage (IEC61000-4-2)(Contact)	V _{ESD}	(Note 1)	±30	kV
Electrostatic discharge voltage (IEC61000-4-2)(Air)				
Peak pulse power(tp = 8/20 μs)	P _{PK}		32	W
Peak pulse current(tp = 8/20 μs)	I _{PP}	(Note 2)	2.5	Α
Junction temperature	Tj		150	°C
Storage temperature	T _{stg}		-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: According to IEC61000-4-2.

Note 2: According to IEC61000-4-5.

Start of commercial production



4. Electrical Characteristics (Unless otherwise specified, T_a = 25°C)

 V_{RWM} : Working peak reverse voltage

V_Z: Zener voltage

V_{BR}: Reverse breakdown voltage

Z_Z: Dynamic impedance

Iz: Zener current

I_{BR}: Reverse breakdown current

IR: Reverse current V_C: Clamp voltage

I_{PP}: Peak pulse current R_{DYN}: Dynamic resistance

I_F: Forward current

V_F: Forward voltage

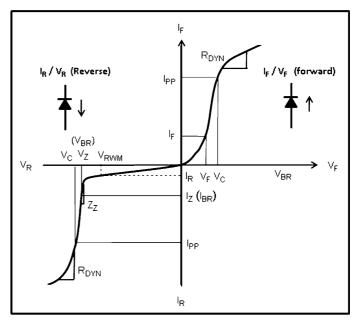


Fig. 4.1 Definitions of Electrical Characteristics

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Working peak reverse voltage	V_{RWM}		_	_	_	3.5	V
Zener voltage (Reverse breakdown voltage)	V _Z (V _{BR})		I _Z = 5 mA (I _{BR} = 5 mA)	5.3	5.6	6.0	V
Dynamic impedance	Z _Z		$I_Z = 5 \text{ mA}$ $(I_{BR} = 5 \text{ mA})$	_		30	Ω
Reverse current	I _R		V _{RWM} = 3.5 V	_		1	μА
Clamp voltage	V _C	(Note 1)	I _{PP} = 1 A	_	6.5	_	٧
			I _{PP} = 2.5 A	_	8.0	13	
Clamp voltage	V _C	(Note 2)	I _{TLP} = 16 A	_	10.5	_	V
			I _{TLP} = 30 A	_	14	_	
Dynamic resistance	R _{DYN}	(Note 2)	_	_	0.25	_	Ω
Total capacitance	Ct	(Note 3)	V _R = 0 V, f = 1 MHz	_	40	_	pF

Note 1: Based on IEC61000-4-5 8/20 μs pulse.

Note 2: TLP parameter: Z0 = 50 Ω , tp = 100 ns, tr = 300 ps, averaging window: t1 = 30 ns to t2 = 60 ns, extraction of dynamic resistance using a least-squares fit of TLP characteristics at IPP between 8 A to 16 A.

Note 3: Guaranteed by design.

Rev.1.0



5. Marking

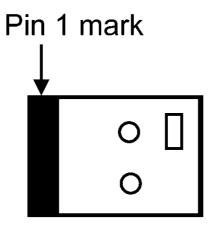


Fig. 5.1 Marking

6. Land Pattern Dimensions (for reference only)

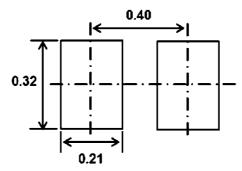


Fig. 6.1 Land Pattern Dimensions (Unit: mm)

7. Characteristics Curves (Note)

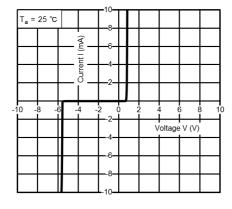


Fig. 7.1 I-V

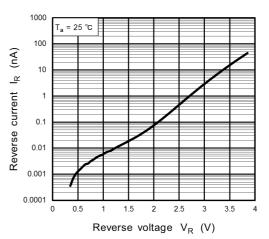
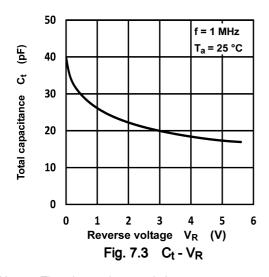


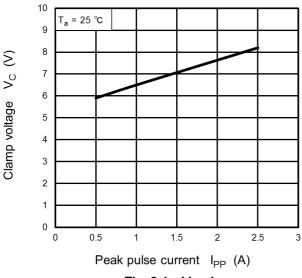
Fig. 7.2 I_R - V_R



Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



8. Clamp Voltage - Peak Pulse Current (V_C - I_{PP}) (Note)



100% 90% 50% 10% 0%

Fig. 8.1 V_C - I_{PP}

Fig. 8.2 Based on IEC61000-4-5 8/20 μ s pulse.(Ed.2)

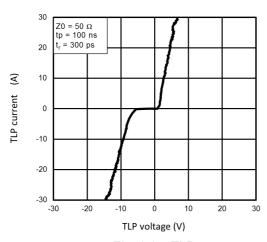
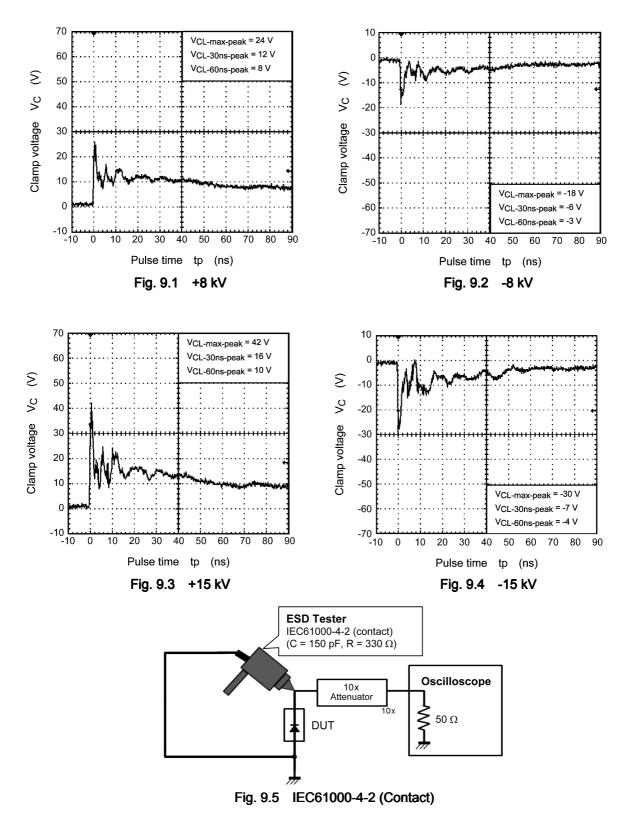


Fig. 8.3 TLP

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



9. ESD Clamp Waveform (Note)

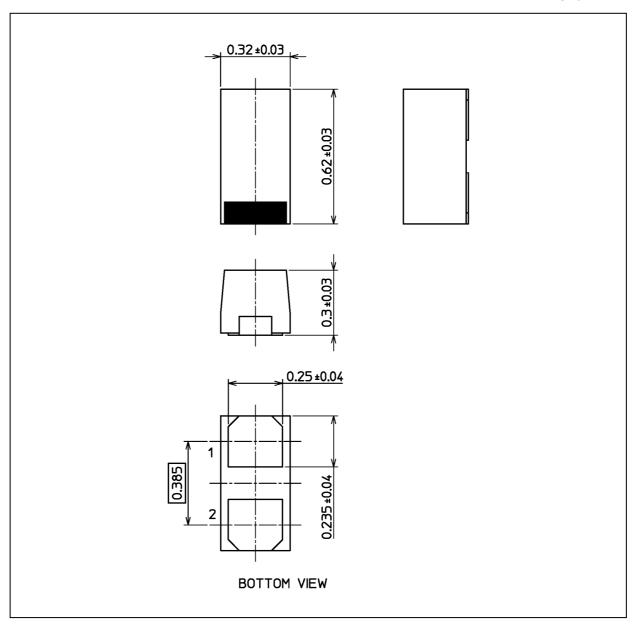


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.2 mg (typ.)

Package Name(s)
TOSHIBA: 1-1AL1A
Nickname: SL2

Rev.1.0



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